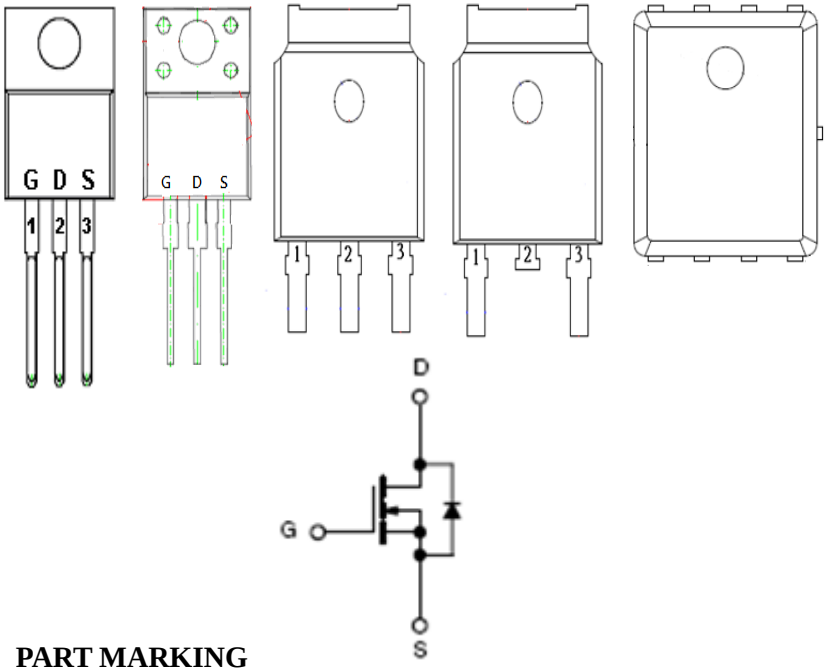
SPN70T10
N-Channel Enhancement Mode MOSFET

DESCRIPTION
The SPN70T10 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

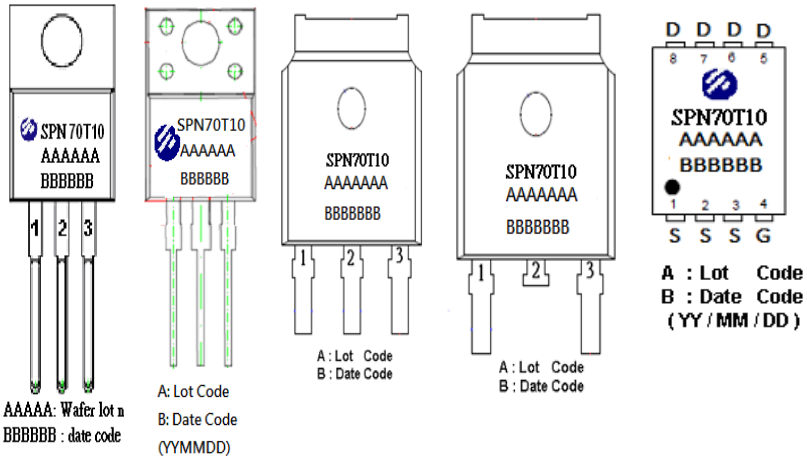
APPLICATIONS
- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Power Tool
- Motor Control

FEATURES
- 100V/70A,$R_{DS(ON)}$=12mΩ@V_{GS}=10V
- 100V/70A,$R_{DS(ON)}$=15mΩ@V_{GS}=4.5V
- Super high density cell design for extremely low $R_{DS\ (ON)}$
- Exceptional on-resistance and maximum DC current capability
- TO-220-3L/TO-220F-3L/TO-251S-3L/TO-252-2L /PPAK5x6-8L package design

PIN CONFIGURATION
TO-220 TO-220F TO-251 TO-252 PPAK5x6



PART MARKING



PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6 PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN70T10T220TGB	TO-220-3L	SPN70T10
SPN70T10T220FTGB	TO-220F-3L	SPN70T10
SPN70T10ST251TGB	TO-251S-3L	SPN70T10
SPN70T10T252RGB	TO-252-2L	SPN70T10
SPN70T10DN8RGB	PPAK5x6-8L	SPN70T10

※ SPN70T10T220TGB : Tube ; Pb – Free ; Halogen – Free
※ SPN70T10T220FTGB : Tube ; Pb – Free ; Halogen – Free
※ SPN70T10ST251TGB : Tube ; Pb – Free ; Halogen - Free
※ SPN70T10T252RGB : Tape Reel ; Pb – Free ; Halogen – Free
※ SPN70T10DN8RGB : Tape Reel ; Pb – Free ; Halogen – Free

SPN70T10
N-Channel Enhancement Mode MOSFET

ABSOULTE MAXIMUM RATINGS

(T_A=25℃ Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	100	V
Gate –Source Voltage		V_{GSS}	±20	V
Continuous Drain Current(Silicon Limited)	T_C=25℃	I_D	73	A
	T_C=70℃		52	
Continuous Drain Current(Silicon Limited) (PPAK5x6)	T_C=25℃	I_D	62	A
	T_C=70℃		40	
Pulsed Drain Current		I_{DM}	190	A
Power Dissipation@ Tc=25℃	TO-220	P_D	104	W
Power Dissipation@ Tc=25℃	TO-251S/TO-252/TO-220F		93	
Power Dissipation@ Tc=25℃	PPAK5x6		83	
Avalanche Energy with Single Pulse (Tj=25℃, L = 1mH , I_{AS} = 22A , V_{DS} =100V.)		E_{AS}	240	mJ
Operating Junction Temperature		T_J	-55/150	℃
Storage Temperature Range		T_{STG}	-55/150	℃
Thermal Resistance-Junction to Case (TO-220/TO-220F)		$R_{\theta JC}$	1.2	℃/W
Thermal Resistance-Junction to Case (TO-251S/TO-252)		$R_{\theta JC}$	1.35	℃/W
Thermal Resistance-Junction to Case (PPAK5x6)		$R_{\theta JC}$	1.5	℃/W

Note :

The maximum current rating is package limited at 120A for TO-220-3L
The maximum current rating is package limited at 78A for TO-220F-3L
The maximum current rating is package limited at 70A for TO-251S-3L and TO-252-2L
The maximum current rating is package limited at 80A for PPAK5x6-8L

ELECTRICAL CHARACTERISTICS

(T_A=25℃ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	100			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	1.4	1.9	2.4	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=80V,V_{GS}=0V T_J = 25℃			1	uA
		V_{DS}=80V,V_{GS}=0V T_J = 100℃			100	
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=10V,I_D=20A		9.5	12	mΩ
		V_{GS}=4.5V,I_D=20A		11.5	15	
Gate Resistance	R_G	V_{GS}=0V,V_{DS}=Open, f=1MHz		1.5		Ω
Diode Forward Voltage	V_{SD}	I_F=20A,V_{GS} =0V		0.9	1.2	V
Dynamic						
Total Gate Charge	Q_g(10V)	V_{DS}=50V,V_{GS}=10V I_D= 14A		29		nC
Total Gate Charge	Q_g(4.5V)			14		
Gate-Source Charge	Q_{gs}			5		
Gate-Drain Charge	Q_{gd}			5		
Input Capacitance	C_{iss}	V_{DD}=50V,V_{GS}=0V f=1MHz		2275		pF
Output Capacitance	C_{oss}			162		
Reverse Transfer Capacitance	C_{rss}			7.9		
Turn-On Time	$t_{d(on)}$	V_{DD}=50V, I_D=14A,V_{GS}=10V R_G=10Ω		8		nS
	t_r			3		
Turn-Off Time	$t_{d(off)}$			26		
	t_f			4		
Reverse Recovery Time	trr	V_R=50V, I_F=12A, d I_F/dt=500A/uS		33		nS
Reverse Recovery Charge	Qrr			157		nC

TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

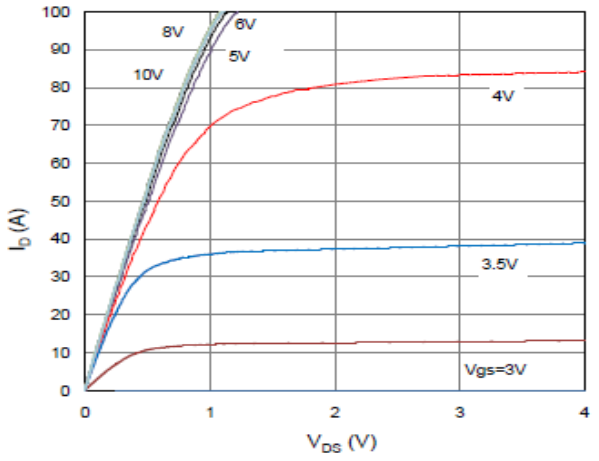


Figure 2. On-Resistance vs. Gate-Source Voltage

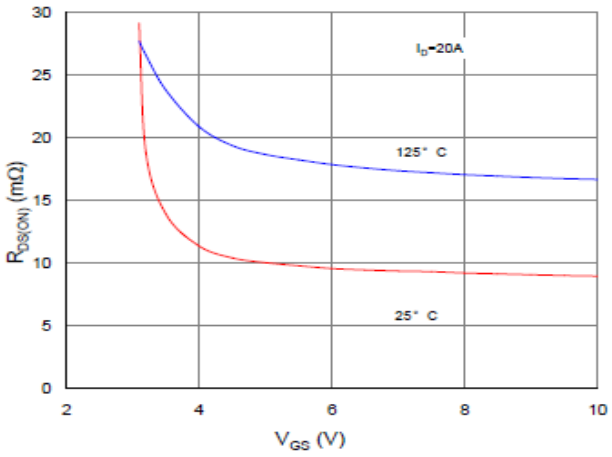


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

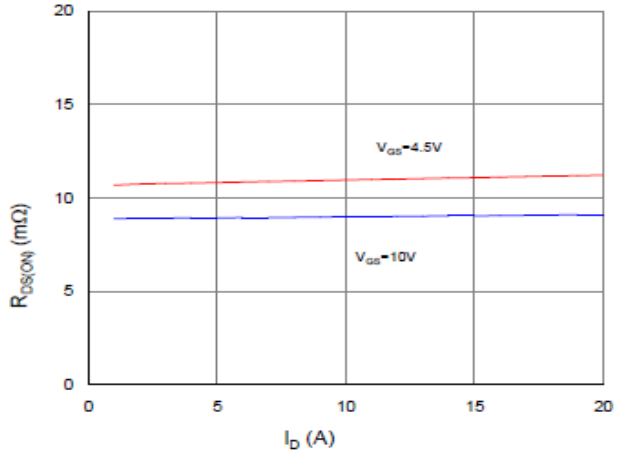


Figure 4. Normalized On-Resistance vs. Junction Temperature

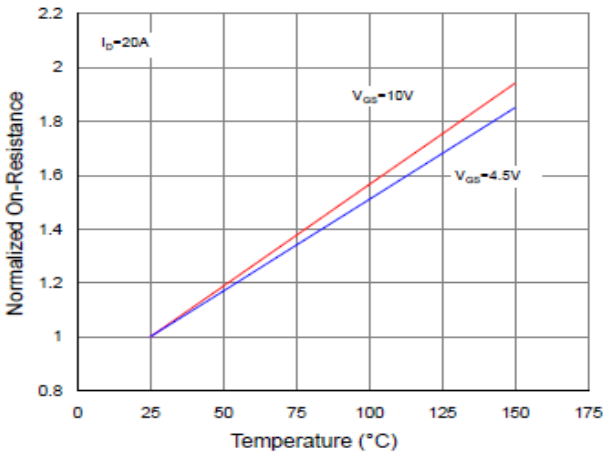


Figure 5. Typical Transfer Characteristics

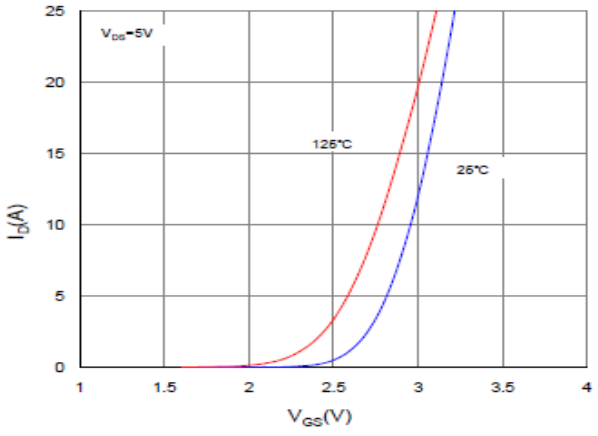
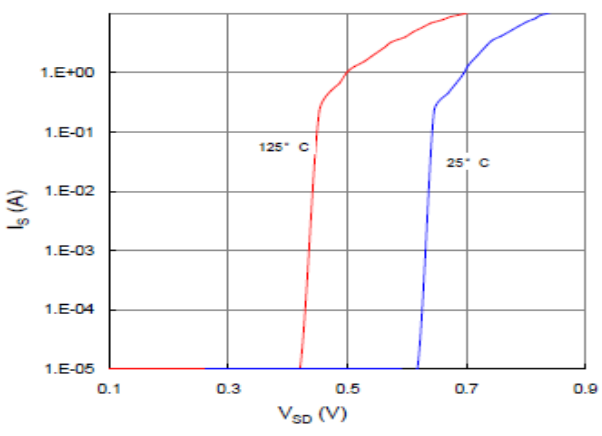


Figure 6. Typical Source-Drain Diode Forward Voltage



TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

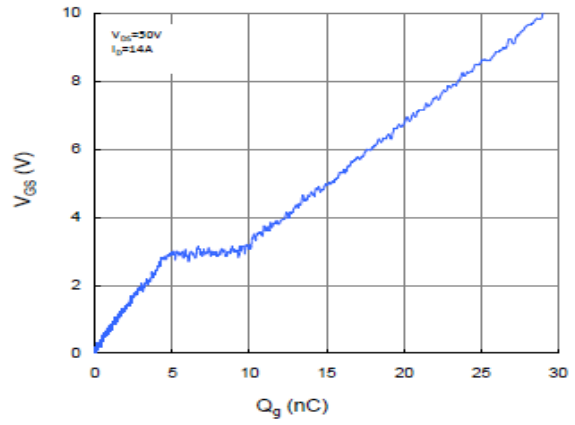


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

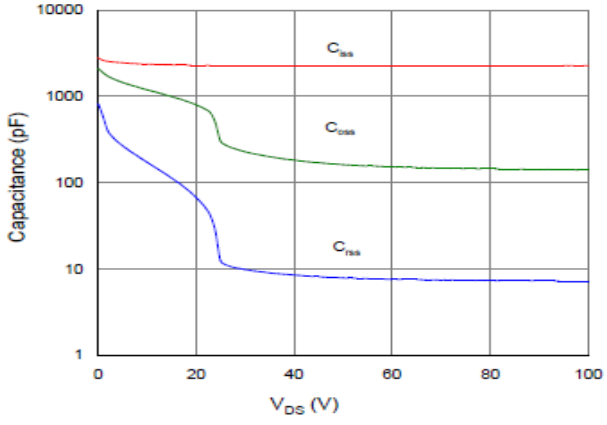


Figure 9. Maximum Safe Operating Area

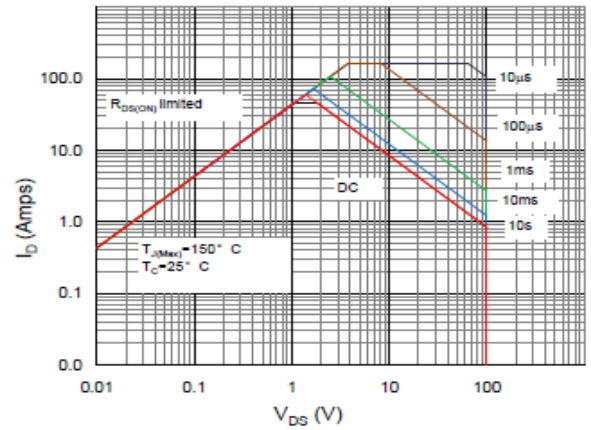


Figure 10. Maximun Drain Current vs. Case Temperature

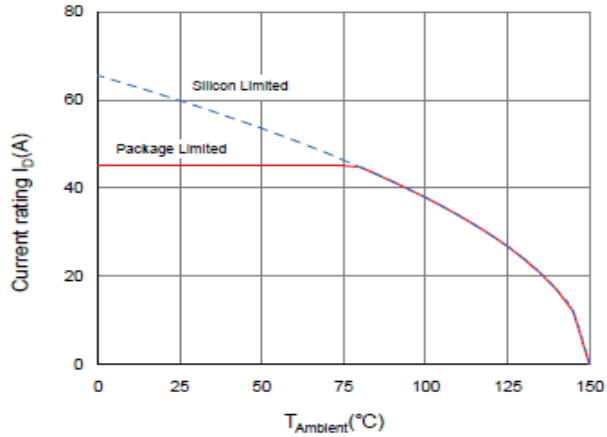
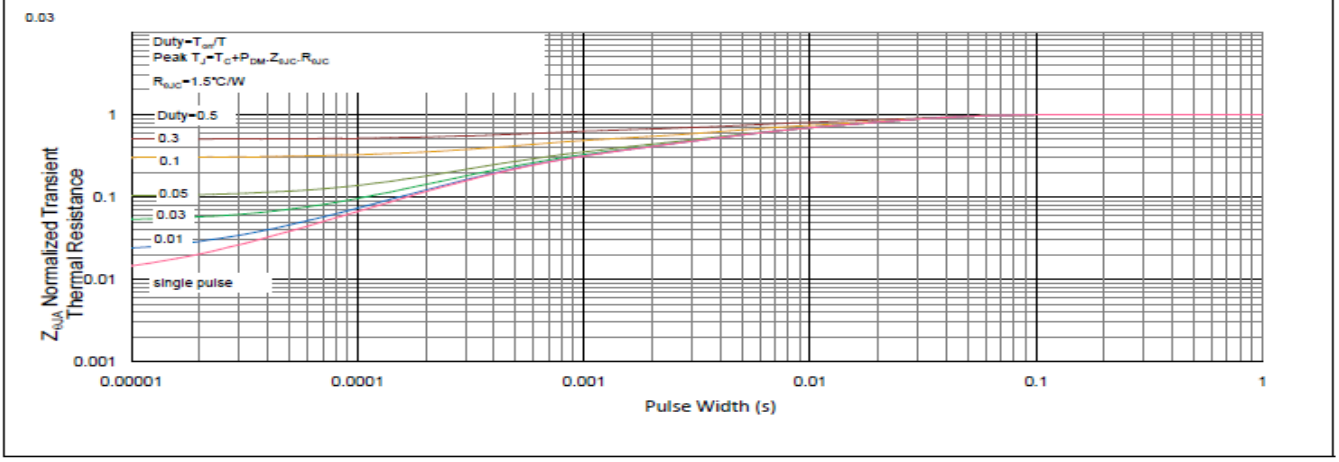
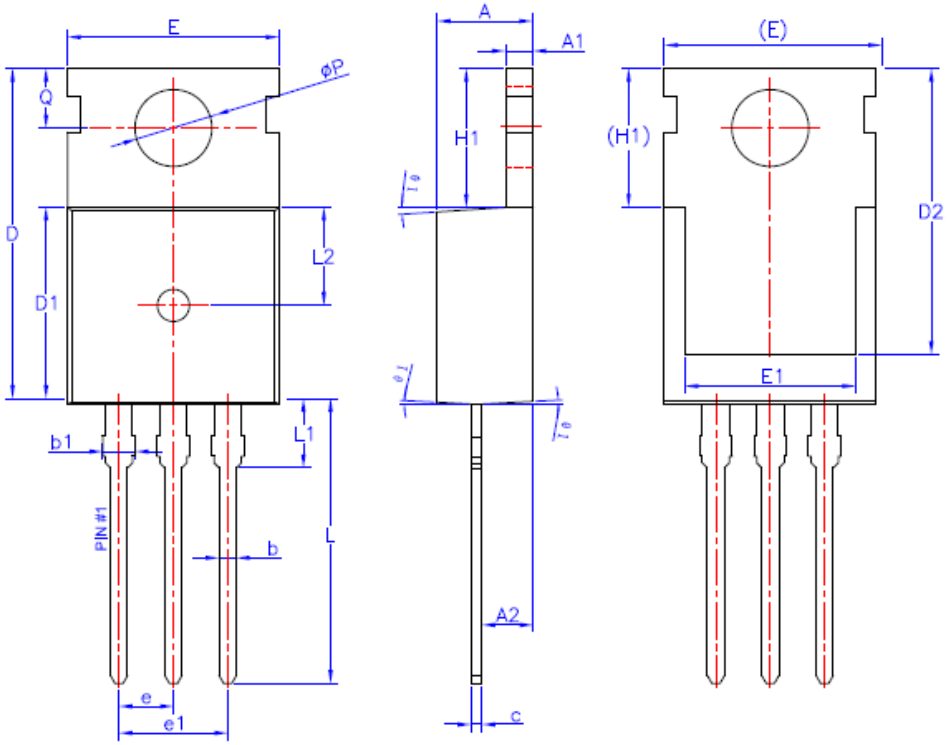


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

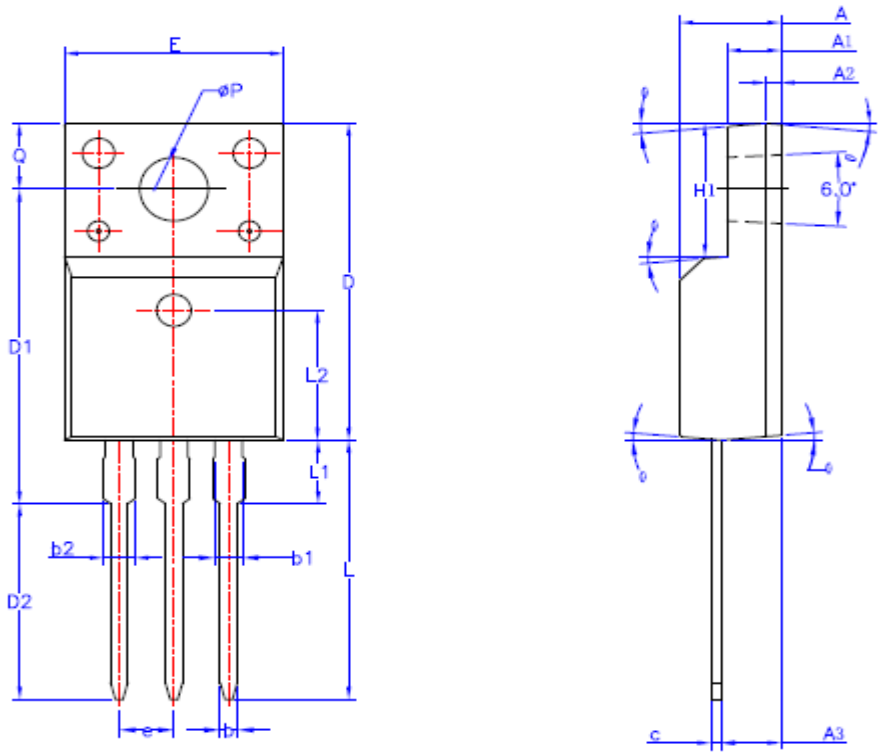


TO-220-3L PACKAGE OUTLINE



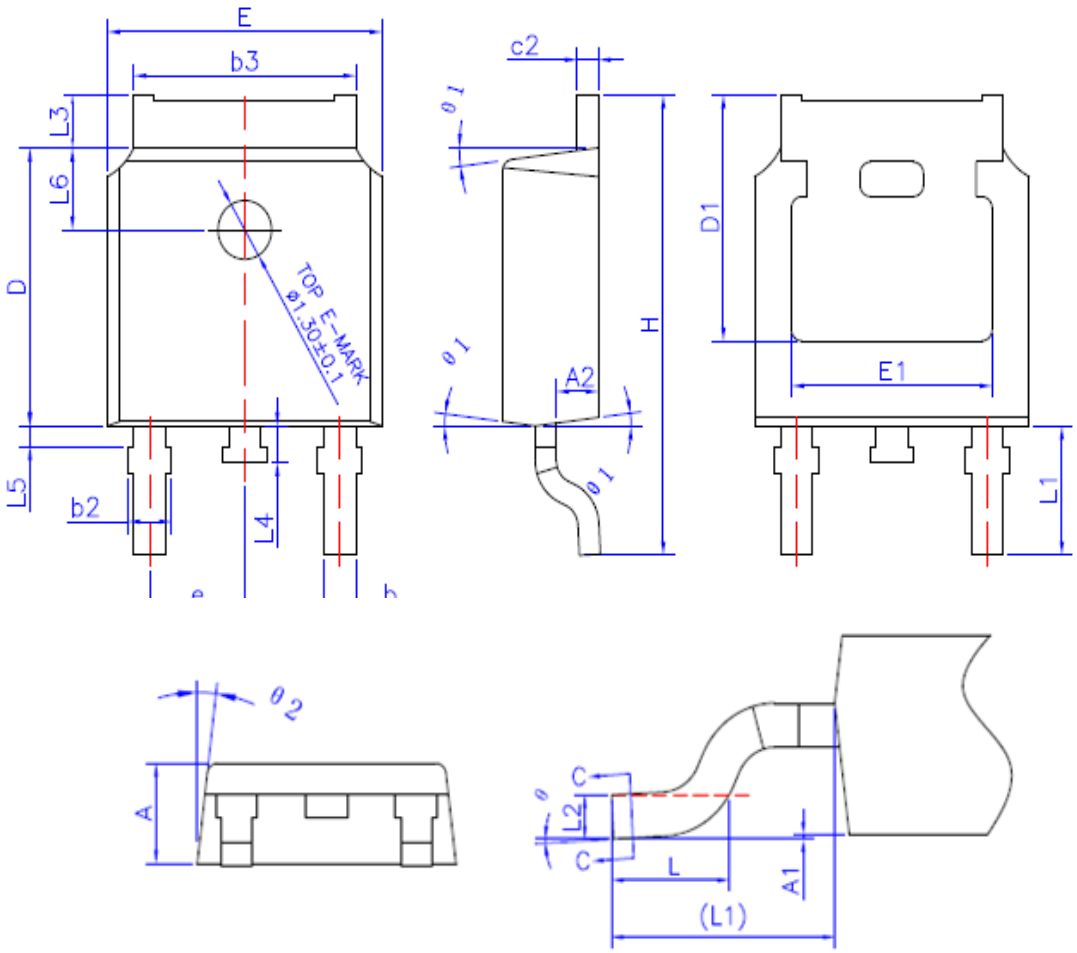
SYMBOL	MIN	NOM	MAX
A	4.40	4.50	4.60
A1	1.27	1.30	1.33
A2	2.30	2.40	2.50
b	0.70	0.60	0.90
b1	-	-	1.40
c	0.45	0.50	0.60
D	15.30	15.70	16.10
D1	9.10	9.20	9.30
D2	13.10	-	13.70
E	9.70	9.90	10.20
E1	7.80	8.00	8.20
e	2.54BSC		
e1	5.08BSC		
H1	6.30	6.50	6.70
L	12.78	13.08	13.38
L1	-	-	3.50
L2	4.6REF		
φ P	3.55	3.60	3.65
Q	2.73	-	2.87
θ 1	1°	3°	5°

TO-220F-3L PACKAGE OUTLINE



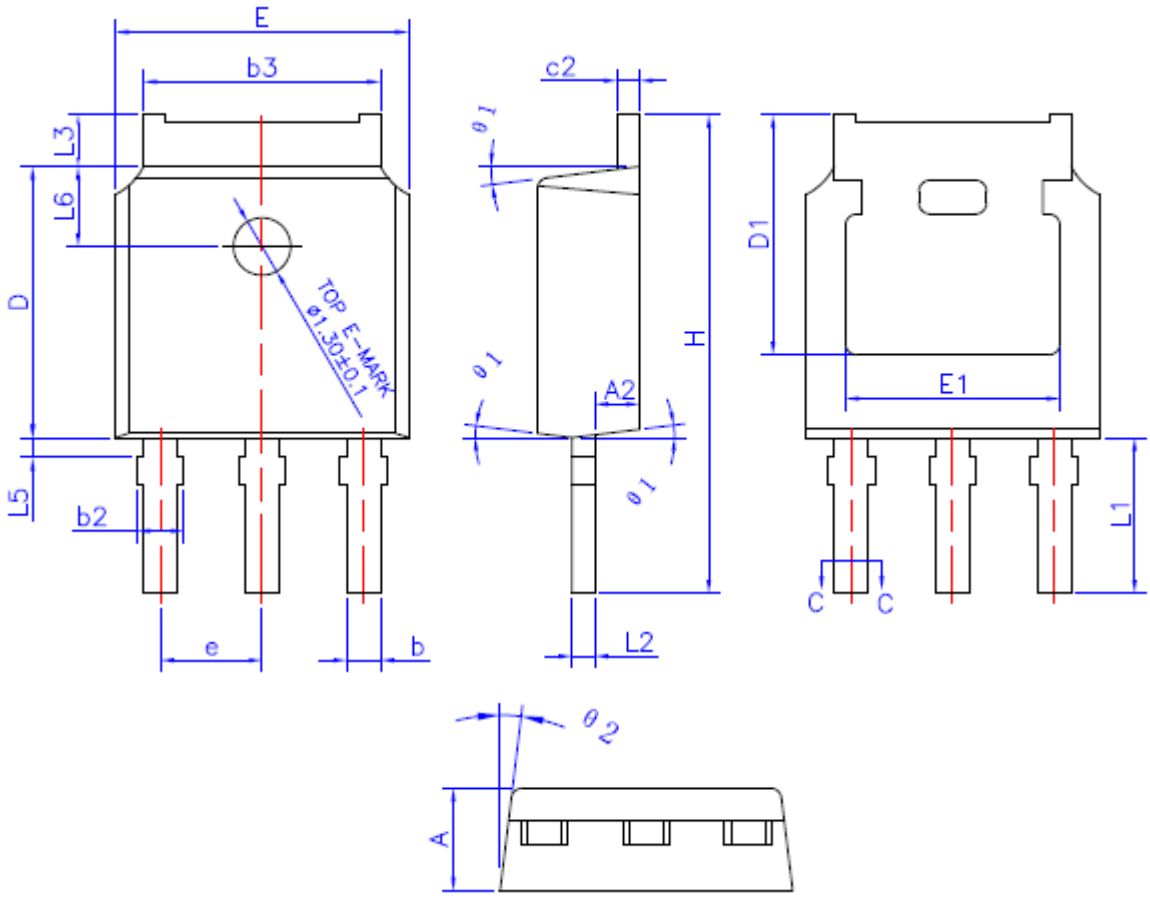
SYMBOL	MIN	NOM	MAX
A	4.50	4.70	4.83
A1	2.34	2.54	2.74
A2		0.7REF	
A3	2.56	2.76	2.93
b	0.70	--	0.90
b1	1.18	--	1.40
b2	--	--	1.47
c	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
D2	9.60	9.80	10.00
E	9.96	10.16	10.36
e		2.54BSC	
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	-	-	3.50
L2		6.50REF	
φ P	3.08	3.18	3.28
Q	3.20	-	3.40
θ 1	1°	3°	5°

TO-252-2L PACKAGE OUTLINE



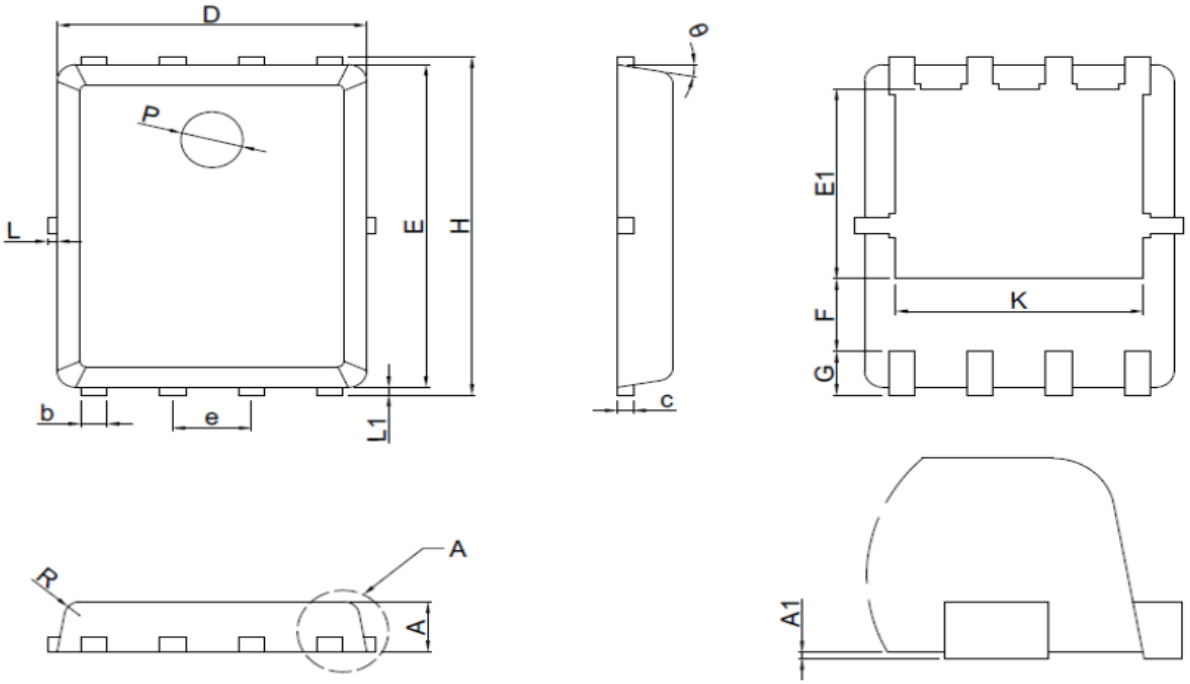
SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	--	0.15
A2	0.90	1.01	1.10
b	0.72	-	0.85
b2	0.72	--	0.90
b3	5.13	5.33	5.46
c	0.47	--	0.60
c2	0.47	--	0.60
D	6.00	6.10	6.20
D1	5.25	--	--
E	6.40	6.60	6.80
E1	4.70	--	--
e	2.3REF		
H	9.80	10.10	10.40
L	1.40	1.60	1.80
L1	2.90REF		
L2	0.508BSC		
L3	0.90	--	1.25
L4	0.60	0.80	1.00
L5	0.15	--	0.75
L6	1.80REF		
θ	0°	3°	8°
θ 1	5°	7°	9°
θ 2	5°	7°	9°

TO-251S-3L PACKAGE OUTLINE



SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A2	0.86	1.01	1.16
b	0.66	-	0.86
b2	0.66	--	0.96
b3	5.10	5.28	5.46
c	0.46	--	0.60
c2	0.47	--	0.60
D	6.00	6.10	6.20
D1		5.35REF	
E	6.40	6.60	6.80
E1		4.83REF	
e		2.3REF	
H	9.80	10.40	11.00
L1		3.50REF	
L2		0.508BSC	
L3	0.90	--	1.25
L5	0.15	--	0.75
L6		1.80REF	
θ 1	5°	7°	9°
θ 2	5°	7°	9°

PPAK5x6-8L PACKAGE OUTLINE



SYMBOL	MILLIMETERS		
	MIN	NOM	MAX
A	0.8	0.95	1.1
A1	0.00	0.03	0.05
b	0.33	0.41	0.51
c		0.254 REF	
D	4.80	4.95	5.10
F		1.40 REF	
E	5.70	5.80	5.90
e		1.27 BSC	
H	5.90	6.05	6.20
L1	0.06	0.13	0.20
G		0.60 REF	
K		4.00 REF	
L	---	----	0.20
P		1.00 REF	
E1		3.40REF	
θ	6°	10°	14°
R		0.25REF	

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